

RTD Input Module

Product Specifications and Installation Data

1 DESCRIPTION

The HE693RTD720 Input Modules allow RTD temperature sensors to be directly connected to the PLC without external signal processing (transducers, transmitters, etc.). All analog and digital processing of the RTD signal is performed on the module, and temperature values in 0.125°C, 0.1°C, 0.5°C, 0.1°F or 0.5°F increments are written to the 90-30 %Al input table. The module features six channels, and supports PT-100 (platinum, 100Ω at 0°C), Ni-120 (nickel, 120Ω at 0°C), Cu-10 (Copper, 10Ω at 25°C) or Pt-1000 (platinum, 1000Ω at 0°C). This module has been specially coated and potted for environmental considerations.

2 INSTALLATION

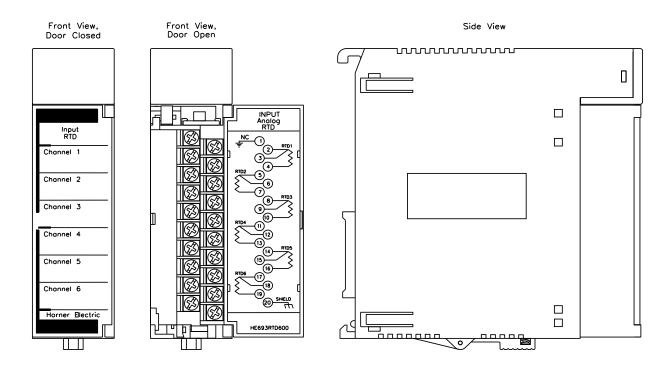


Figure 1 - HE693RTD720

13 September 1999 MAN0194-03

3 **SPECIFICATIONS**

Table 1 – RTD720 Specifications				
Power Consumption (typical)	75mA @ 5VDC	I/O Points Required	6%AI	
Number of Channels	6	Input Impedance	>1000 Megohms	
Types Supported				
Pt-100E	-100 to 850°C	Fault Protection	Zener Diode Clamp	
Pt-100C	-100 to 650°C	A/D Conversion Type	18 bit, Integrating	
Ni-120	-100 to 270°C	Update Time	50 Channels per second	
Cu-10	-200 to 260°C	Average RTD current, Pt-100	330 microamps	
Pt-1000	-100 to 850°C	Channel to Channel Tracking	0.1°C	
Resolution	0.125°C, 0.1°C, 0.5°C,	Operating	0 to 60°C	
	0.1 °F or 0.5°F	Temperature	(32 ti 140°F)	
Accuracy	±0.5°C, typical	Relative Humidity	5% to 95% non-condensing	

CONFIGURATION

4.1 **Configuration Procedure**

SERIES 90-30 MODULE IN RACK 2 SLOT 2 SOFTWARE CONFIGURATION						
SLOT 2	Catalog #: FOI		MAE COMP	FOREIGN MO	DULE	
FRGN	Module ID : XI Ref Adr : XI Size : XQ Ref Adr : XQ Size : XAI Ref Adr: XAI Size : XAQ Ref Adr: XAQ Size :	3 ×10001 0 ×Q0001 0 ×A1001 6 ×AQ001	Byte 1 Byte 2 Byte 3 Byte 4 Byte 5 Byte 6 Byte 7 Byte 8	: 00000001 : 00000100 : 33 : 00 : 00 : 00 : 00	Byte 9 Byte 10 Byte 11 Byte 12 Byte 13 Byte 14 Byte 15 Byte 16	: 00 : 00 : 00 : 00

Figure 2 – Foreign Module Configuration Screen

To reach the Foreign Module Configuration screen:

- a. Select I/O Configuration (F1).b. Cursor over to the slot containing the module and select Other (F8), and Foreign (F3).
- c. Set parameters (refer to Table 1).

PAGE 2 **13 SEPTEMBER 1999**

4.1.1 Configuration Parameters

Table 1 indicates the five necessary parameters for configuring the HE693RTD720 (refer to Figure 1). Change the various bytes (1-4) and set %Al to "6" to reach the desired set-up.

Table 2 – Configuration Parameters for RTD720					
%Al Size	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5
			00=Pt-100	00=0.5°C	00 th rough
		0000	01=Ni-120		
6 0001	0000 thru	02=Pt-100	01=0.5°F 02=0.125°C	00 through 0A See dwell	
	0111	03=Cu-10			
		(see chart)	04=Reserved	03=0.1°C 04=0.1°F	table.
			05=Pt-200	- 04-0.11	

4.1.2 Digital Filtering (Byte 2)

Figure 3 indicates the effect of digital filtering (set with Byte 2 from Table 1) on module response to a temperature change. (% temp change completed vs. time).

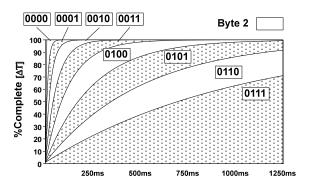


Figure 3 - Digital Filtering

4.1.3 Temperature Scaling (Byte 4)

The RTD module reports values to the %Al table in 0.125 or 0.1 increments in either °C or °F (set with Byte 4 from Table 1). Conversion to actual degrees is shown in Table 2.

Table 3 – Temperature Scaling		
Module Configuration	Temperature Conversion	
0.125°C	°C = %AI / 8	
0.1°C	°C = %AI / 10	
0.1°F	°F = %AI / 10	
0.5°C	°C = %AI / 2	
0.5°F	°F = %AI / 2	

Note: The above values occur during normal operation. If a wiring fault occurs, refer to Table 5.

13 SEPTEMBER 1999 PAGE 3

4.1.4 Channel Dwell Time (Byte 5)

The RTD720 module multiplexes a single excitation current source between the six channels to improve channel to channel temperature tracking and to lower the average RTD current to reduce RTD self-heating errors. Each channel is normally driven for 22 milliseconds. For some applications such as electronic RTD simulators and other time dependent RTD sources, the channel dwell time can be insufficient. Byte 5 of the configuration can be used to increase this time as shown in Table 4. Longer channel dwell times increase the total scan time proportionally.

Table 4 – Channel Dwell Time vs. Byte 5 Value		
Byte 5	Seconds	
00	0.022	
01	0.044	
02	0.088	
03	0.175	
04	0.350	
05	0.700	
06	1.400	
07	2.800	
08	5.600	
09	11.20	
0A	22.40	

5 WIRING

5.1.1 Wiring Diagram

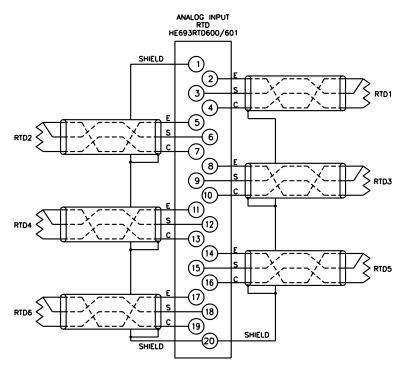


Figure 4 - Wiring Diagram

PAGE 4 13 SEPTEMBER 1999

5.1.2 Wiring Installation Hints

Wiring must be routed in its own conduit.

Shielded, twisted wiring offers the best noise immunity.

If shielded wiring is used, a good earth ground connection (on one end only) is critical. If shields are connected at the module end, terminals 1 or 20 can be used as the shield ground point.

For proper RTD lead resistance compensation, the lead resistances must be matched and must be no more than 50 ohms each.

5.1.3 Wiring Fault Conditions

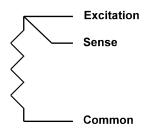


Figure 5 - Temperature Sensor

Figure 5 depicts a close-up view of the temperature sensor wiring. Consult Table 5 for wiring fault conditions.

Table 5 – Wiring Fault Conditions		
Fault Condition	%Al Value	
Short Circuit	Low Limit	
Excitation Open	Low Limit	
Sense Open	Low Limit	
Common Open	High Limit	

6 TECHNICAL ASSISTANCE

For user manual updates, contact Horner APG, Technical Support Division, at (317) 916-4274 or visit our website at www.heapg.com.

7 REVISIONS TO THIS DATA SHEET

This version of the data sheet for the HE693RTD720 contains the following revisions and additions:

- 1. Revised temperature values in Section 1. (Added 0.5°C and 0.5°F.)
- 2. Revised Resolution and Accuracy parameters in Table 1.
- 3. Revised Byte 4 and Byte 5 parameters in Table 2.
- 4. Revised Temperature parameters in Table 3. (Added 0.5°C and 0.5°F.)
- 5. Revised Table 4 (Byte 5 parameters) and added "OA" parameter.

13 SEPTEMBER 1999 PAGE 5